

Features

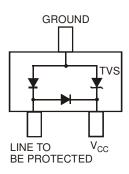
- 300 Watts Peak Pulse Power (tp = 8×20µs)
- Transient Protection for Data Line to IEC61000-4-2 Level 4 (ESD), 8kV HBM
 - Contact: Discharge ±30kV
 - Air: Discharge ±30kV
- IEC 61000-4-4 (EFT)
- Low Leakage Current
- Surface Mount Package Ideally Suited for Automated Insertion
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Package: SOT323
- Package Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
 Lead Free Plating (Matte Tin Finish Annealed over Alloy 42
 Leadframe) (3)
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)



Top View



Device Schematic

Ordering Information (Note 4)

Part Number	Baakaga	Packing	
Part Number	Package	Qty.	Carrier
DLPT05WA-7	SOT323	3,000	Tape & Reel

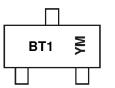
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\begin{array}{l} BT1 = Product Type Marking Code \\ YM = Date Code Marking \\ Y = Year (ex: J = 2022) \\ M = Month (ex: 9 = September) \end{array}$

Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	J	K	L	М	Ν	0	Р	R	S	Т	U	V
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Pulse Power (tp = 8×20µs, per Figure 2)	Ррк	300	W
Peak Forward Voltage (IPP = 1A, tp = 8×20µs, per Figure 2)	V _{FP}	2.1	V
Diode Peak Repetitive Reverse Voltage	VRRM	75	V

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 5)	Reja	625	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Reverse Standoff Voltage		n Voltage @ Ιτ	Test Current	Max. Reverse Leakage @ V _{RWM} (Note 6)	Max. Clamping Voltage @ IPP = 1A (Notes 7 & 8)	Typical Peak Pulse Current (Notes 7 & 8)	Typical Total Capacitance (Note 9)
VRWM (V)	Min (V)	Max (V)	Iт (mA)	I _R (μΑ)	Vc (V)	IPP (A)	(pF)
5	6.0	—	1.0	20	9.8	17	1.9

Notes:

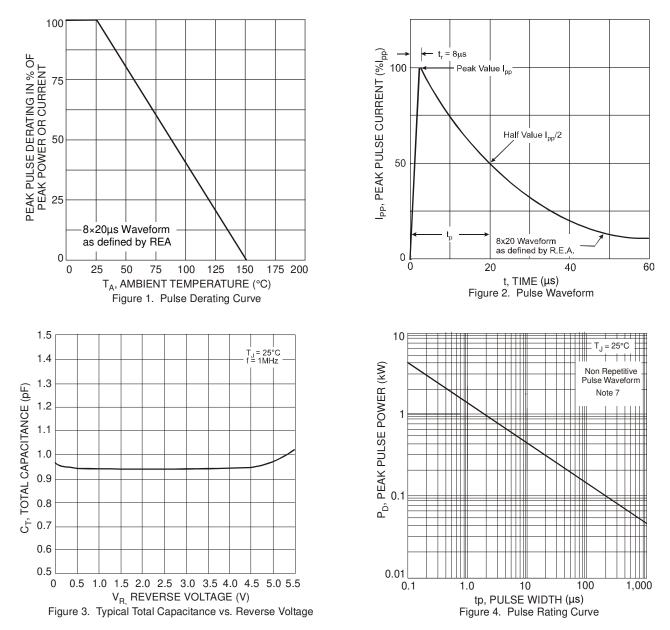
5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html. 6. Short duration pulse test used to minimize self-heating effect.

7. Clamping voltage value is based on an 8×20µs peak pulse current (IPP) waveform.

8. Measured from line to be protected to ground pin.

9. V_{R} = 0V, f = 1MHz from line to be protected to ground pin.

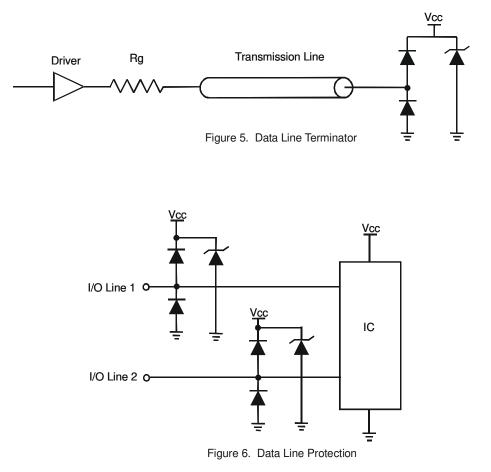




Note: 7. Clamping voltage value is based on an 8×20µs peak pulse current (IPP) waveform.



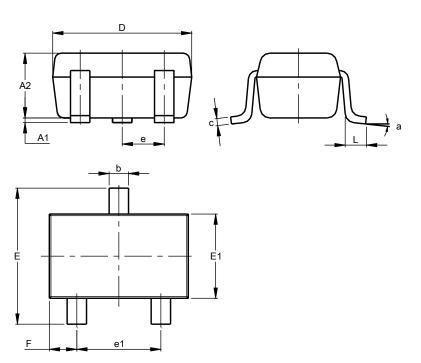
Typical Application Schematics





Package Outline Dimensions

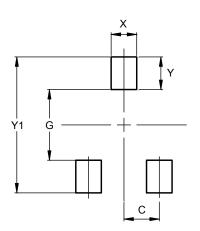
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT323						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.25	0.40	0.30			
c	0.10	0.18	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
e1	1.20	1.40	1.30			
F	0.375	0.475	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)	
С	0.650	
G	1.300	
Х	0.470	
Y	0.600	
Y1	2.500	

SOT323



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